Standing Mesochannels: Mesoporous PdCu Films with Vertically Aligned Mesochannels from Nonionic Micellar Solutions

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Supporting Information

ABSTRACT: Mesoporous bimetallic palladium (Pd) alloy films with mesochannels perpendicularly aligned to the substrate are expected to show superior electrocatalytic activity and stability. The perpendicular mesochannels allow small molecules to efficiently access the active sites located not only at the surface but also within the film because of low diffusion resistance. When compared to pure Pd films, alloying with a secondary metal such as copper (Cu) is cost-effective and promotes resistance against adventitious poisoning through intermediate reactions known to impair the electrocatalytic performance. Here, we report the synthesis of mesoporous PdCu films by electrochemical deposition in nonionic micellar solutions. The mesoporous structures are vertically aligned on the substrate, and the final content of Pd and Cu can be adjusted by tuning the initial precursor molar ratio in the electrolyte solution.

KEYWORDS: mesoporous materials, palladium, copper, alloys, vertically aligned mesochannels, nonionic surfactant, micelles

INTRODUCTION

Mesoporous materials are a promising platform for many applications, such as catalysis, energy conversion and storage, sensing, drug delivery, and adsorption. In particular, mesoporous metal films have the potential to enhance the oxidation reactions of small molecules and the oxygen reduction reactions by combining high catalytic activity and high surface area. Designing and fabricating mesoporous metal films with ordered mesochannels promoting the transport of guest molecule species is still a challenge. In particular, a well-ordered perpendicular mesochannel structure is expected to provide short migration distances for the reactants and products and increase the diffusion rate of the guest molecular species. However, the compositions of such architectures have been limited to metal oxides and carbons until now.

So far, the common approaches to fabricate mesoporous metal films have relied on hard-templating methods. Unfortunately, these techniques require much effort to grow metallic frameworks or nanoparticles inside the templates, while maintaining both the mesostructure and the morphology. Metallic films with uniform mesopores can also be fabricated

Received: August 9, 2018
Accepted: October 23, 2018
Published: November 14, 2018
using cationic surfactants, in the present study, we extend to enhance the electrocatalytic activity and stability, and the mesochannels has been never reported. The fabrication of bimetallic PdCu alloy to resist contamination.25 reveal strong Cu−Cu interactions and the capability of the bimetallic PdCu alloy to resist contamination.25−27 However, the fabrication of bimetallic PdCu alloy films with ordered mesochannels has been never reported.

Herein, we combine the advantages of both the bimetallic alloy and the perpendicular mesochannel structure, which not only lead to enhance the electrocatalytic activity and stability, but also to increase the diffusion rate of the guest molecule species. Although we previously reported the fabrication of mesoporous Pd films with vertically oriented mesochannels using cationic surfactants,17 in the present study, we extend this concept to an alloy, using a different surfactant system. We prepared PdCu films with mesochannels vertically aligned on the substrate by a simple nonionic surfactant (Pluronic P123) micelle-assisted electrodeposition process from aqueous electrolyte solutions (Scheme 1). The electrocatalytic activity of the as-deposited films toward ethanol oxidation was studied as the model reaction.

Scheme 1. Scheme Illustrating the Formation Mechanism of Vertically Aligned Mesochannels in the PdCu Films: (a) Micelle Formation and Three-Electrode System for Electrodeposition; (b) Growth of PdCu Vertical Mesochannels by Micelles Decorated with Pd and Cu Metal Species

EXPERIMENTAL SECTION

Chemicals. Pluronic P123 and palladium black (PdB) were obtained from Sigma-Aldrich (USA). Ethanol and sulfuric acid were purchased from Nacalai Co. (Japan). Palladium(II) chloride, copper(II) sulfate, and potassium hydroxide were obtained from Wako Chemicals (Japan). All the chemicals were used without any prior treatment. Double-distilled water with a specific resistivity of 18.2 MΩ cm was provided by Merck Milli-Q water purification system.

Electrochemical Deposition. All the potential values in this work are reported versus Ag/AgCl, unless specified. Electrochemical deposition of mesoporous PdCu films was conducted utilizing an electrochemical station (CHI 842B electrochemical analyzer, CHI Instruments, USA). The conventional three-electrode system was employed: Au-coated Si wafer substrate (3 mm × 15 mm), Ag/AgCl electrode, and Pt wire were used as the working, reference, and counter electrodes, respectively. The Au conductive layer was deposited on the Si wafer by a sputtering technique (~20 nm), with the Ti thin layer as the bonding element (~5 nm). First, two aqueous stock solutions of 80 mM PdCl₂ and 80 mM CuSO₄ were prepared (note that a few drops of 2 M HCl solution were added to avoid precipitation). The electrolyte consisted of a nonionic micellar solution prepared by dissolving 2.0 wt % P123 (critical micelle concentration (cmc) 0.18 wt % at 293 K) along with the metal solutions of Pd(II) chloride and copper(II) sulfate, and potassium hydroxide were obtained from Wako Chemicals (Japan). All the chemicals were used without any prior treatment. Double-distilled water with a specific resistivity of 18.2 MΩ cm was provided by Merck Milli-Q water purification system.

Characterization. The morphology of the mesoporous PdCu films was examined by field emission scanning electron microscopy (Hitachi SU-8230 at an accelerating voltage of 5 kV), Transmission electron microscopy (TEM), high-resolution TEM, high-angle annular dark field (HAADF) images, and energy-dispersive X-ray (EDX) mapping were obtained with a JEOL JEM-2100F at an accelerating voltage of 200 kV. Wide-angle X-ray diffraction (XRD) patterns were acquired with a Rigaku SmartLab X-ray diffractometer equipped with a Cu Kα X-ray source. Two-dimensional (2D) grazing-
incidence small-angle X-ray scattering (GI-SAXS) profiles were collected with a Rigaku NANO-Viewer (Microfocus rotating anode; Cu Kα radiation; 40 kV, 30 mA) equipped with a camera length of 680 mm. Ultraviolet-visible (UV–vis) absorption spectroscopy of the electrolyte solutions was performed by a JASCO V-7200. The surface elemental composition and electronic coordination state of the as-prepared PdCu films were analyzed by X-ray photoelectron spectroscopy (XPS; PHI Quantera SXM; ULVAC-PHI; Al Kα radiation). All XPS spectra were calibrated to the C 1s peak at 285.0 eV. To gather information about molar ratio on the final PdCu film product, inductively coupled plasma optical emission spectroscopy (ICP-OES) was carried out on a Hitachi model SPS3520UV-DD.

**Electrochemical Measurements.** All the electrochemical measurements were recorded on a CHI 842B electrochemical analyzer (CH Instrument, USA) with a standard three-electrode system. As-deposited PdCu films on Au-coated Si substrate was employed as the working electrode. The Ag/AgCl electrode and the standard calomel electrode (SCE) were used as the reference electrodes in acidic medium and basic medium electrolytes, respectively. A Pt wire was utilized as the counter electrode. The cyclic voltammetry (CV) measurements were recorded in a 0.5 M H₂SO₄ electrolyte at a scan rate of 50 mV s⁻¹ between −0.2 and +1.2 V. The electrocatalytic performance toward the ethanol oxidation reaction was recorded in 1.0 M KOH containing 1.0 M C₂H₅OH in a potential range from −0.8 to 0.3 V (vs SCE). All the CV measurements were repeated three times for each sample. Amperometric i–t curves were recorded at a fixed potential of −0.2 V (vs SCE) for 1200 s in 1.0 M KOH containing 1.0 M C₂H₅OH to study the stability. Other working electrodes were prepared for performance comparison: mesoporous Pd and nonporous PdCu films deposited on an Au-coated Si substrate and commercial palladium black (PdB). A 5 μL of 1 mg mL⁻¹ PdB was drop-cast on a polished glassy carbon electrode followed by coating with a Nafion resin solution and dried in an ambient atmosphere prior to electrochemical measurements.

**RESULTS AND DISCUSSION**

A conventional three-electrode system was employed for the deposition of mesoporous PdCu films: Au-coated Si wafer substrate, Ag/AgCl electrode, and Pt wire were used as the working, reference, and counter electrodes, respectively. The electrolyte solution consisted of a nonionic micellar solution prepared by dissolving 2.0 wt % P123 (cmc 0.18 wt % at 293 K) along with the metal precursors (PdCl₂ and CuSO₄) in double-distilled water. To optimize the system, various Pd/Cu molar ratios (90:10, 80:20, 70:30, 60:40, and 50:50) and deposition times (50, 100, 150, and 200 s) were tested, whereas the applied deposition potential was fixed to −0.4 V. To remove the soft templates, the as-deposited mesoporous PdCu films were rinsed thoroughly with double-distilled water and dried under a nitrogen gas flow. For comparison, mesoporous Pd films (without Cu) and nonporous PdCu films (without P123) were also fabricated (Figure S1).

According to the previously reported scattering data obtained by small-angle neutron scattering, it is proved that the nonionic surfactant, Pluronic P123, forms spherical-shaped micelles in water with an average diameter ca. 13 nm (Figure S2). The micelle core consists of a hydrophobic moiety (polypropylene oxide, PPO block) and its shell of a hydrophilic moiety (polyethylene, PEO block). Even after the addition of metal precursors, the average diameter of the spherical-shaped micelles does not change significantly. To study the interactions among the solvent, micelles, and the metal precursors, optical absorption spectroscopy was carried out on various aqueous solutions (Figure S3). The UV–vis absorption study shows the existence of two metal aqua complexes: [Cu(H₂O)₆]²⁺ ions and [PdCl₄(H₂O)]⁻(2+e⁻) ions, where the Cl⁻ ions are exchanged with the water molecules. These water-coordinated Pd and Cu ions in the electrolyte solutions interact with the PEO groups of the micelles through hydrogen bonding.

The potential applied during the electrodeposition of mesoporous PdCu films was determined after studying the reduction potential of the Pd and Cu ions in the electrolyte solution by linear sweep voltammetry (LSV) (Figure 1). In our previous work, we found that the reduction potential to carry out the reduction of Pd ions into Pd(0) in an electrolyte solution containing micelles was around 0.0 V. In accordance with the LSV plot in Figure 1, the reduction of Pd and Cu ions into PdCu alloys starts at ca. −0.2 V. The formation of hydrogen bubbles is observed beyond −0.4 V. The electrodeposition of PdCu films was then carried out at −0.2, −0.3, and −0.4 V to ensure the reduction of both Pd and Cu precursors, as well as to avoid the detrimental effects caused by the generation of hydrogen bubbles on the film structure. The optimal deposition voltage was determined after observing the morphology of the films from the cross-sectional and top scanning electron microscopy (SEM) as well as GI-SAXS images (Figure 2). The SEM images reveal that carrying out the deposition at −0.4 V leads to a smooth and uniform structure (Figure 3a,b), unlike the films deposited at −0.2 and −0.3 V (Figure 2). The 2D scattering profiles of the films deposited at −0.2 and −0.3 V show a half-ring pattern, which indicates that the pores are randomly packed, whereas clear spots can be observed on the left and right sides of the beam for the film deposited at −0.4 V, indicating well-ordered mesochannels vertically aligned on the substrate (A detailed discussion on the obtained GI-SAXS spots is given in a later section). The cross-sectional TEM and HAADF–scanning transmission electron microscopy (STEM) images of the mesoporous Pd₄₋₉Cu₁₉ film show that all the mesochannels are standing on the substrate (Figure 3c,d).

Our method enables a simple and accurate approach to tune the metal composition of the final film, which was found to closely match the initial precursor molar ratio (Table 1). Mesoporous PdCu films deposited at −0.4 V were synthesized with different Pd/Cu molar ratios. According to the ICP-OES analysis, the samples are designated as Pd₄₋₉Cuₓ where x and 100 − x correspond to the atomic percentage of Pd and Cu, respectively. It is worth mentioning that the film thickness can simply be increased with the deposition time, without affecting the integrity of the mesoporous structure (Figure 4). The top
view of the mesoporous $\text{Pd}_x\text{Cu}_{100-x}$ films observed by SEM reveals the pores distributed uniformly throughout the entire surface (Figures 3a,b and S4). The average pore size, statistically calculated from over 100 pores, was found to be in the range between 7 and 9 nm. GI-SAXS was further employed to characterize the pore ordering and periodicity of the films with various Pd/Cu ratios. The half ring (halo) observed on the 2D scattering profile of the pure Pd film indicates the existence of isotropic periodicity, whereas the two spots observed for the alloyed films suggest that the mesochannels are aligned perpendicularly to the substrate (Figure 5). The samples showing spots overlapping with a pseudo-half ring consist of aligned channels with a mild degree of isotropy. As mass transport is expected to be favored in well-aligned mesochannels, electrocatalytic activity should decrease as the degree of isotropy increases. The converted 2D scattering (in-plane) profiles of each mesoporous $\text{Pd}_x\text{Cu}_{100-x}$ film sample show a distinct peak located between $q = 0.4$ and 0.5 nm$^{-1}$ (Figure 5). Although all the mesochannels in the alloyed films are vertically aligned, the in-plane ordering is not perfectly arranged. Therefore, the resulting pore-to-pore distance can be roughly estimated from the $d$ values of the in-plane spots. The pore-to-pore distances are 12.4, 12.4, 12.6, 13.0, and 13.3 nm for $\text{Pd}_{91}\text{Cu}_9$, $\text{Pd}_{81}\text{Cu}_{19}$, $\text{Pd}_{71}\text{Cu}_{29}$, $\text{Pd}_{61}\text{Cu}_{39}$, and $\text{Pd}_{51}\text{Cu}_{49}$, respectively. These values are well-supported by the top surface SEM images (Figure S4).

In light of these results, we propose the following mechanism for the formation of mesochannels in the PdCu films: the hydrophobic moiety of P123 in the electrolyte solution maintains the stability of the micelles, whereas the hydrophilic moiety can solvate or attract the metal ion complex species through hydrogen-bonding [−$\text{CH}_2\text{CH}_2\text{O}$···$\text{H}_2\text{O}$−$\text{Cu}$(II) or $\text{Pd}$(II)] and electrostatic interactions. Notice also that the pH of the solution is around 2, which means that the $\text{SO}_4^{2-}$ ions are protonated ($\text{HSO}_4^-$); this chaotropic agent further enhances the micellization of P123 (increases the micelle concentration in the media). As the charge of the Pd(II) complexes varies from −2 to +2 with increasing the water content in the coordination sphere and also the Cu$^{2+}$ ion coordination sphere is water, the presence of coordinated water is important for the assembly and also for interaction of metal ions with the ethylene oxide domains for accumulating metal ions [Pd(II) as well as Cu(II)] in and around the micelles. When a potential is applied on the Au-coated Si substrate (working electrode), the generated electromotive force attracts the Pd(II)/Cu(II) complex ions (along with the micelles) toward the working electrode, where they are reduced to their metallic state. The basis for the reductive and transformative reaction is the current, which passed through the working electrode. Note that the applied deposition potential in this work was $-0.4$ V versus Ag/AgCl and that the standard reduction potentials of $[\text{PdCl}_4]^{2-}/\text{Pd}$ and $\text{Cu}^{2+}/\text{Cu}$ are 0.591 and 0.342 V versus SHE, respectively. As a result, the films are electrochemically deposited on the substrate, with the PdCu alloy crystallizing around the micelles, forming the mesochannels (Scheme 1).

During the metallic growth, the spherical micelles fuse together to form cylindrical micelles, thereby leading to the assembly of mesochannels aligned perpendicularly to the substrate. In general, the fusion of spherical triblock copolymer micelles into rodlike micelles is affected by the temperature and the quality of the solvent (i.e., addition of ethanol, acid, and salts). In some cases, the sphere-to-rod transition can be observed by adjusting the polymer-to-precursor ratio.
However, in the present study, this transition does not seem to be affected by these factors. As shown in Figure 2, the quality of the mesoporous structures is mostly affected by the deposition potential. At low voltage (slow deposition rate), the micelles tend to remain spherical. Therefore, it is assumed that the fusion of spherical micelles into rodlike micelles occurs at a faster deposition rate (−0.4 V). In addition, the hydrophobicity of the substrate should have negligible interactions with the hydrophilic moiety of the micelles, thus accommodating the growth of the mesochannels along the vertical direction.28,29 The Pd–Cu alloy oxidation states in the framework were confirmed by XRD, XPS, and elemental mapping (Figures S5–S8, Table S1). The Pd and Cu elements are spread throughout the metallic pore walls, as confirmed by EDX elemental mapping and line-scanning compositional profile (Figure 3e–h).

The electrochemical active surface area (ECSA) of Pd-based electrocatalysts can be estimated by CV and CO-stripping experiment (Figures S9, S10 and Table S2). The catalyst films were studied for the electro-oxidation reaction of ethanol molecules. On the Pd mass-normalized CV curve of the mesoporous alloyed films shown in Figure S11a, the clear anodic peaks observed in the forward scan are a signature of the oxidation of chemisorbed ethanol.34 The Pd81Cu19 film showed a superior mass-normalized peak current density (2.77 A mg⁻¹), compared to the other alloyed films and also compared to the three control and benchmark samples: mesoporous Pd films (1.75 A mg⁻¹), nonporous Pd81Cu19 films (1.01 A mg⁻¹), and PdB (0.71 A mg⁻¹) (Figure S11a). Even when normalized by their respective surface areas, the mesoporous Pd81Cu19 film still exhibited the highest peak current density among all (Figure S11b). The onset potential of the mesoporous Pd81Cu19 film measured by LSV was more negative than that of the control and benchmark samples (Figure 6), showcasing the importance of both the bimetallic synergy and the aligned mesochannels in enhancing the ethanol oxidation activity. The stability of the electrocatalyst is an important factor for the ethanol oxidation reaction. Therefore, the mesoporous Pd81Cu19 films and control samples were examined for their stability. The Pd81Cu19 film revealed a superior catalytic stability when investigated by the amperometric i–t technique at a constant potential of −0.2 V (vs SCE) for 1200 s (Figure 7).

The feature of the standing mesochannels of Pd81Cu19 films was also investigated by carrying out CV toward ethanol oxidation at various scan rates (Figure 8a–c). The diffusion characteristics of the guest molecular species can be observed from the relationship between a series of square root of the scan rates and the mass activity obtained at the respective scan rates.35 This was achieved by using the parameters extracted from the CV profiles of mesoporous Pd with cage-type mesopores, mesoporous Pd81Cu19 with vertically oriented accommodating the growth of the mesochannels along the vertical direction.28,29 The Pd–Cu alloy oxidation states in the framework were confirmed by XRD, XPS, and elemental mapping (Figures S5–S8, Table S1). The Pd and Cu elements are spread throughout the metallic pore walls, as confirmed by EDX elemental mapping and line-scanning compositional profile (Figure 3e–h).

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mesochannels, and nonporous Pd$_{81}$Cu$_{19}$ films. The gradient of the forward oxidation peak current densities against the square root of the scan rate was larger for the mesoporous Pd$_{81}$Cu$_{19}$ film than those of the mesoporous Pd and nonporous Pd$_{81}$Cu$_{19}$ films (Figure 8d). This phenomenon suggests that the diffusion efficiency of ethanol molecules inside the standing mesochannels is higher than that in the cage-type pores and nonporous film structures.$^{36-39}$

\section*{CONCLUSIONS}

In this work, mesoporous PdCu films with mesochannel structure have been successfully synthesized by surfactant micelle-assisted electrodeposition. The mesoporous structure has a high degree of vertical alignment, as evidenced by GI-SAXS characterization, thus promoting the accessibility of the surface-active sites and lowering the diffusion resistance of the reactant. Also, the presence of Cu atoms in the bimetallic system reduces the capability of the surface to accommodate poisoning products from intermediate reactions. Although the concept of soft-templated electrodeposition of mesoporous metallic alloy films is still at its early stage, it already demonstrates promising outputs, such as for DAFCs devices. In a broader context, the soft-templating approach can be exploited to prepare novel metal nanostructures which have been never reported.$^{40-44}$
SEMs of mesoporous Pd films and nonporous Pd81Cu19 films; schematic model representing P123 micelles in water; UV–Vis absorption spectra of aqueous solutions containing PdCl2, CuSO4, and PdCl2 + CuSO4; diffraction patterns of the mesoporous Pd81Cu19 films; relationship between the Cu content in the as-deposited films and the d-spacings according to Vegard’s law and the XRD diffraction patterns; HRTEM images of the mesoporous Pd81Cu19 and Pd81Cu31 films; first and second cycle CO-stripping voltammetry of mesoporous Pd81Cu9, Pd81Cu19, Pd71Cu29, Pd59Cu41, and Pd49Cu51 films; and Pd mass-normalized and ECSA-normalized CV curves of PdB, nonporous Pd81Cu19 films, mesoporous Pd, Pd81Cu9, Pd81Cu19, Pd71Cu29, Pd59Cu41, and Pd49Cu51 films (PDF).

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**Author Contributions**
The manuscript was written through contributions of all authors. All authors have given approval to the final version of the manuscript.

**Notes**
The authors declare no competing financial interest.

**ACKNOWLEDGMENTS**
This work was supported by the Australian Research Council (ARC) Future Fellow (FT150100479), JSPS KAKENHI (17H05393 and 17K19044), and the research fund by the Suzuken Memorial Foundation. This work was partially performed at the Queensland node of the Australian National Fabrication Facility, a company established under the National Collaborative Research Infrastructure Strategy to provide nano- and micro-fabrication facilities for Australian researchers. M. I. would like to thank the Indonesia Endowment Fund for Education (LPDFI) for the financial support.

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